CERAMIC

Bandpass Filter

BFHK-2492+

50Ω 22 to 28 GHz

THE BIG DEAL

- Ultra-High Stopband Rejection Structure, 80 dB Typ.
- Surface Mountable Pick and Place Standard Case Style
- Standard Small 1812 (4.5x3.2 mm) Case Style
- High Quality Distributed Filter Topology
- Wide Rejection Band
- Shielded Construction Preventing Filter from De-Tuning
- Reduced Footprint Area by Employing LGA (Land Grid Array)
- Suited for Very High-Volume Production
- Protected by US Patent US11744057B1



Generic photo used for illustration purposes only

CASE STYLE: NM1812C-3

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Test and Measurement
- Aerospace and Defense Signal Conditioning

PRODUCT OVERVIEW

The BFHK-2492+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The passband loss at 22-28 GHz is as low as 3.3 dB, with typical stopband rejections at 80 dB up to 50 GHz and 55 dB up to 67 GHz. This model handles up to 1 W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis.

KEY FEATURES

Feature	Advantages
Ultra-High Rejection	Typical stopband rejections at 80 dB up to 50 GHz and 55 dB up to 67 GHz.
Cost Effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small Size (4.5x3.2 mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.

REV. A
ECO-022343
BFHK-2492+
MCL NY
250627

CERAMIC

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ELECTRICAL SPECIFICATIONS[1] AT +25°C

Parameter		F#	Frequency (GHz)		Min.	Typ.	Max.	Units
Passband	Center Frequency					24.9		GHz
	Insertion Loss	F1-F2	22	28		3.3	4.5	dB
	Return Loss	F1-F2	22	28		9.0		dB
Stopband, Lower	Insertion Loss	DC-F3	0.1	16	70.0	85.0		dB
Stopband, Upper	Insertion Loss	F4-F5	34	50	70.0	80.0		dB
			50	67	40.0	55.0		

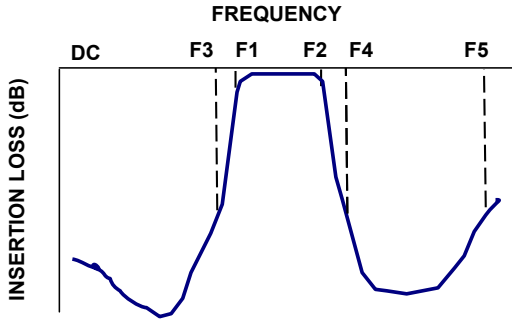
1.Measured on Mini-Circuits Test Board TB-BFHK-2492C+ with connectors and feedlines de-embedded.

ABSOLUTE MAXIMUM RATINGS

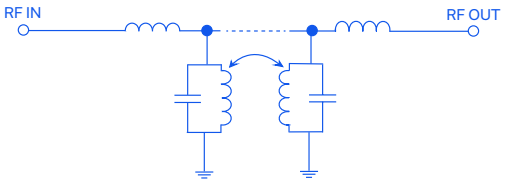
Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
RF Power Input	1 W max.

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



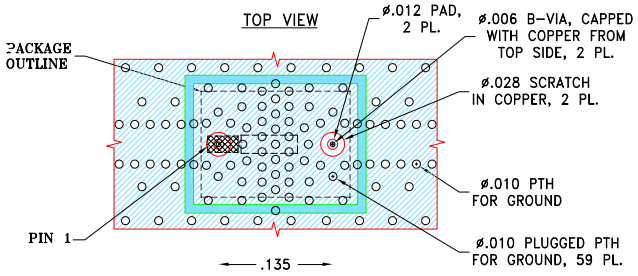
CERAMIC

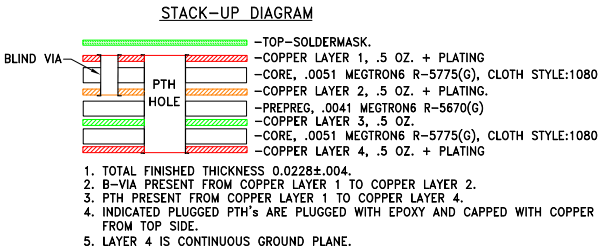
Bandpass Filter

BFHK-2492+

50Ω 22 to 28 GHz

EVALUATION BOARD MCL P/N: TB-BFHK-2492C+
SUGGESTED PCB LAYOUT: PL-730



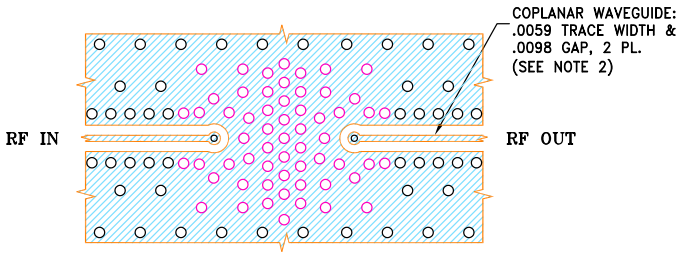


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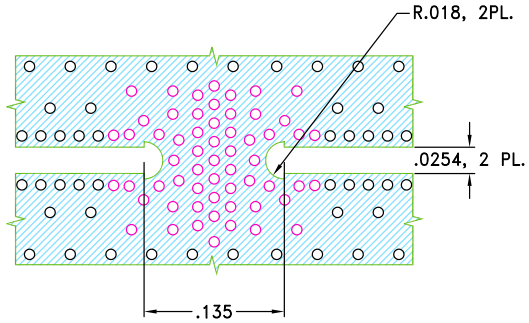
1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK



LAYER 3 & PTH

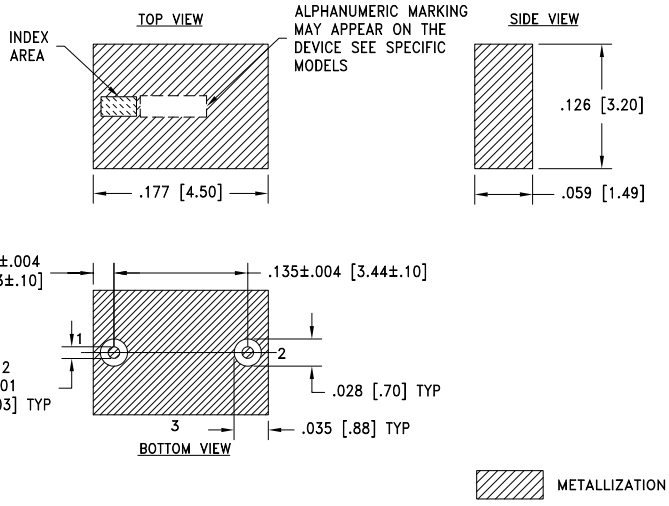


PAD CONNECTIONS

INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: F472

OUTLINE DRAWING



Weight: .126 grams.
Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 Inches

CERAMIC

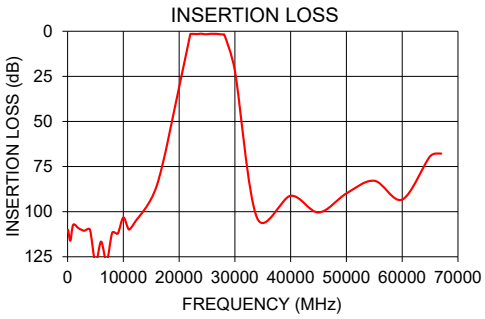
Bandpass Filter

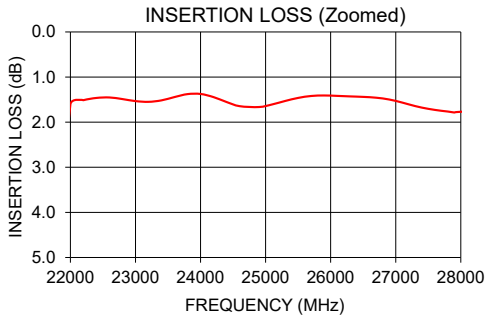
BFHK-2492+

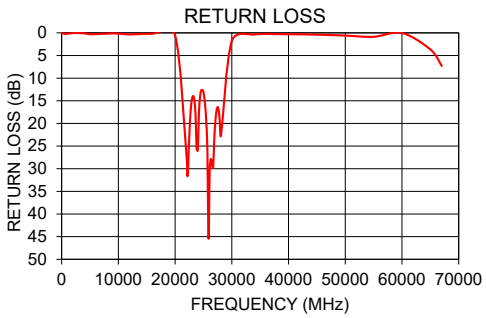
50Ω 22 to 28 GHz

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
25	111.19	0.09
100	110.09	0.10
1000	107.30	0.20
2000	109.26	0.03
3000	110.60	0.05
4000	109.94	0.11
6000	116.59	0.27
7000	127.50	0.22
9000	112.13	0.12
10000	103.21	0.18
11000	109.90	0.25
12000	106.13	0.35
16000	85.51	0.19
22000	1.61	26.90
24900	1.66	12.71
27900	1.79	19.98
28100	1.86	22.57
34000	103.64	0.35
40000	91.17	0.31
50000	89.89	0.60
67000	67.81	7.30







NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

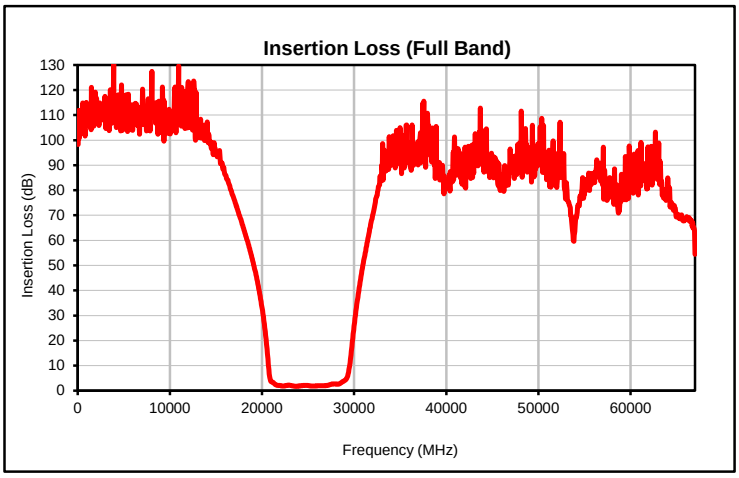
Ceramic Bandpass Filter BFHK-2492+

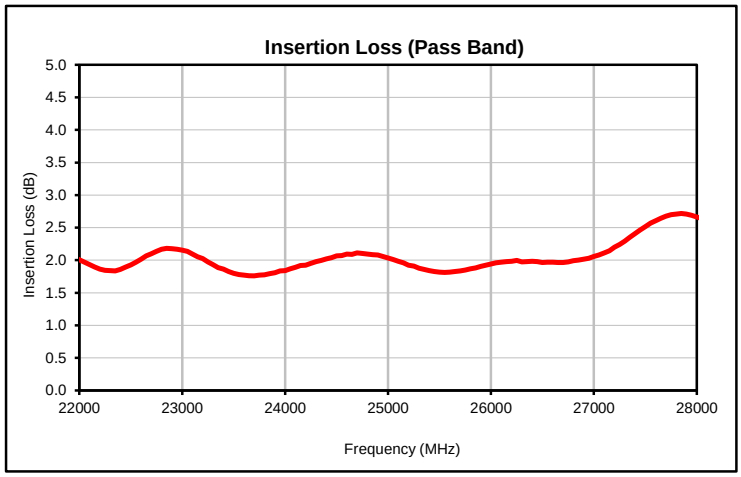
Typical Performance Data

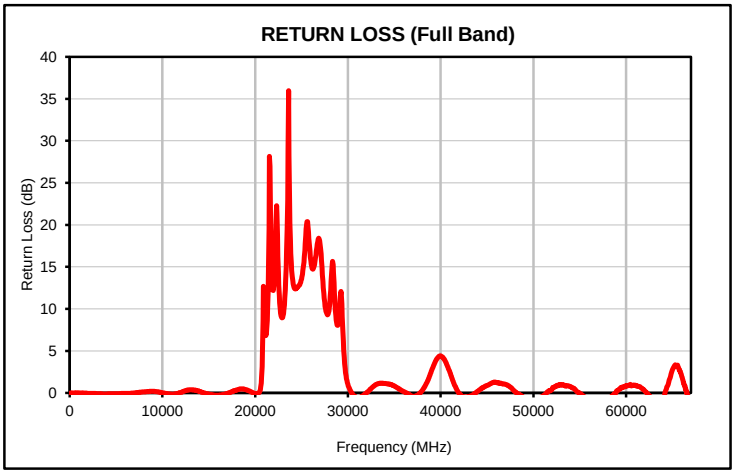
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
100	111.79	-0.02
500	106.58	-0.02
1000	107.96	0.00
2000	107.75	-0.05
3000	109.71	-0.08
4000	110.46	-0.11
5000	114.59	-0.10
6000	107.36	-0.06
7000	113.26	-0.01
8000	112.30	0.13
9000	110.87	0.19
10000	105.72	0.01
11000	111.94	-0.15
12000	123.35	0.07
12600	123.64	0.31
14000	104.27	0.18
15000	94.87	-0.16
16000	86.26	-0.28
17000	76.21	-0.07
18000	64.74	0.35
19000	51.81	0.38
20000	33.23	-0.07
21000	3.59	9.72
22000	2.00	12.58
22500	1.93	14.32
23000	2.15	9.15
23500	1.80	23.01
24000	1.84	13.83
24500	2.07	12.54
25000	2.03	13.54
25500	1.82	19.52
26000	1.94	15.71
26500	1.96	16.04
27000	2.06	17.81
27500	2.52	10.78
28000	2.66	10.12
29000	4.12	8.46
30000	25.79	1.03
31000	50.98	-0.56
32000	70.21	0.01
33000	89.99	0.98
34000	97.56	1.13
35000	105.02	0.83
36000	99.06	0.16
37000	98.63	-0.40
38000	107.59	0.27
39000	88.46	2.57
40000	82.64	4.41
41000	86.88	2.45
42000	81.42	-0.07
43000	86.85	-0.47
44000	93.14	0.18
45000	85.61	0.89
46000	83.69	1.25
47000	89.10	1.01
48000	90.48	0.17
49000	97.00	-0.60
50000	89.95	-0.88
52000	81.05	0.42
54000	65.78	0.76
56000	86.26	-0.89
58000	78.62	-0.95
60000	78.62	-0.95
62000	78.62	-0.95
64000	78.62	-0.95
66000	78.62	-0.95
67000	78.62	-0.95

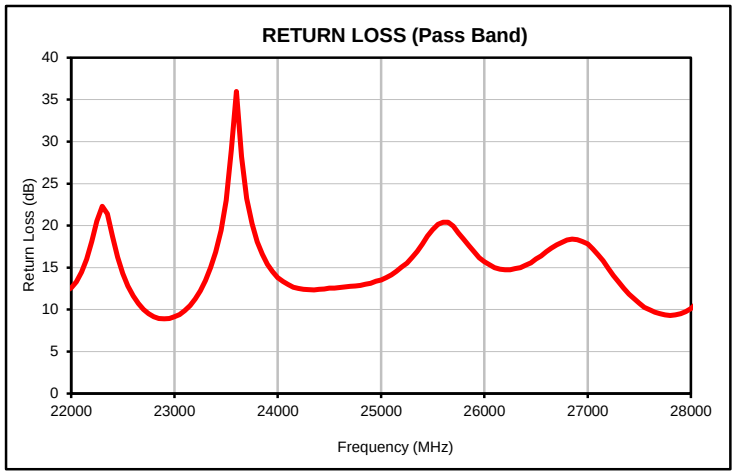
Ceramic Bandpass Filter BFHK-2492+

Typical Performance Curves





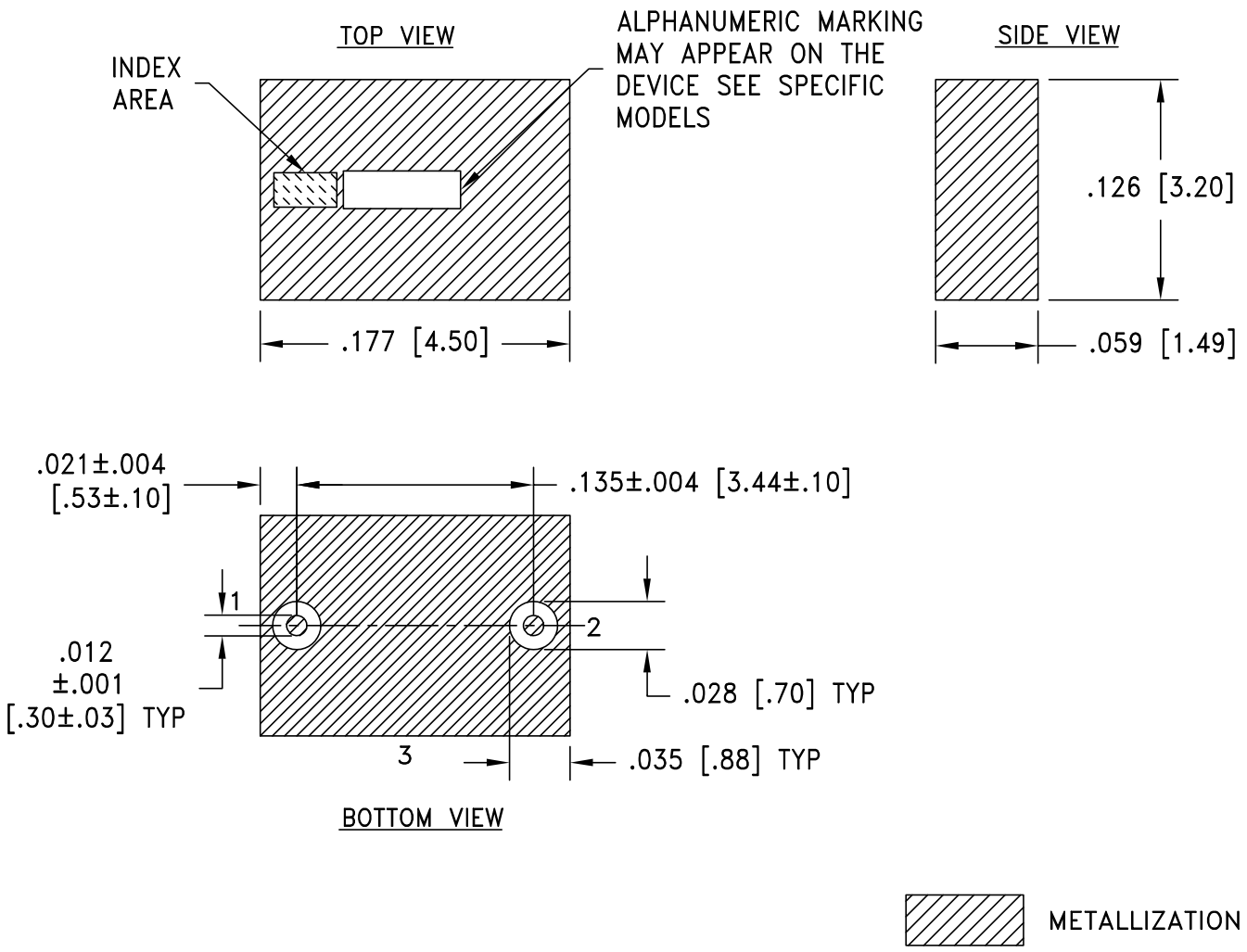




Case Style NM

Outline Dimensions

NM1812C-3



Weight: .126 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 Inches

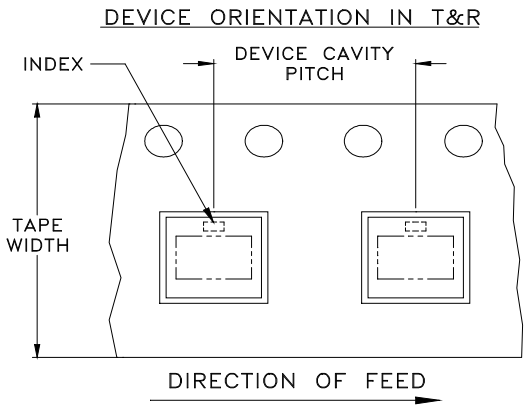
Notes:

1. Case material: Ceramic.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Tin Plate over Nickel plate. All models, (+) suffix.

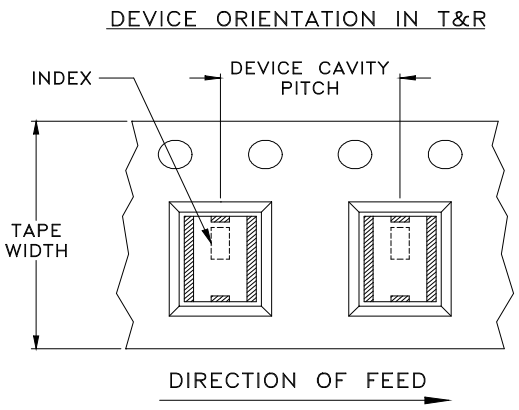
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Tape & Reel Packaging TR-F77



Note: The shape of the pocket may differ



Note: The location and shape of the metallization may differ

Applicable Case Styles
GU1604, GU1804, GU2644, TT1618-2

Applicable Case Styles
MZ4532C, NM1812C, NM1812C-1, NM1812C-2, NM1812C-3, NM1812C-5, NM1812C-6, NM3237 NM1812C-9

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

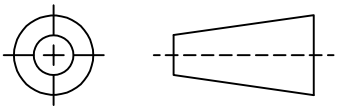
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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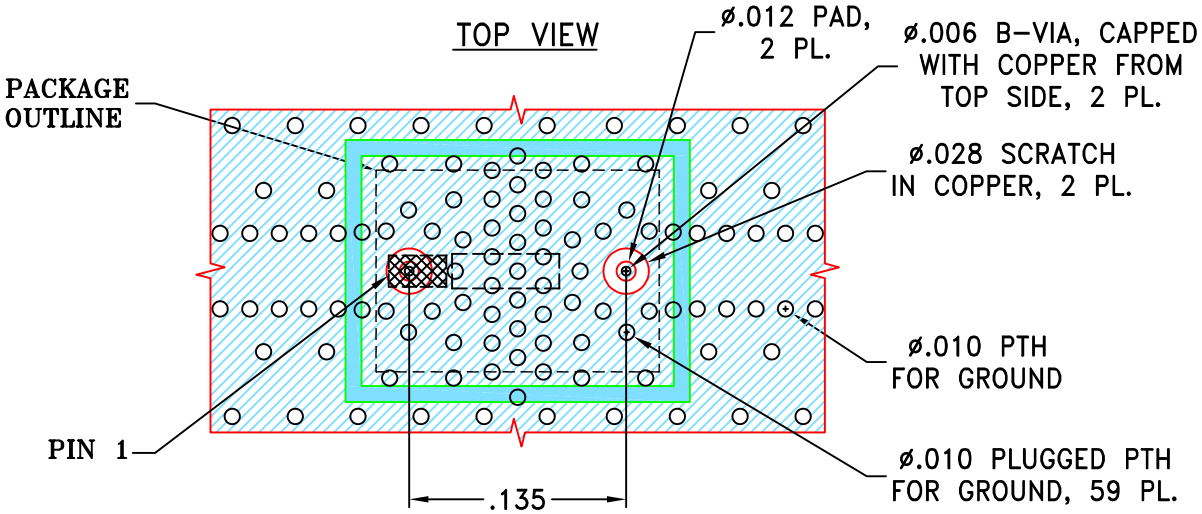
THIRD ANGLE PROJECTION



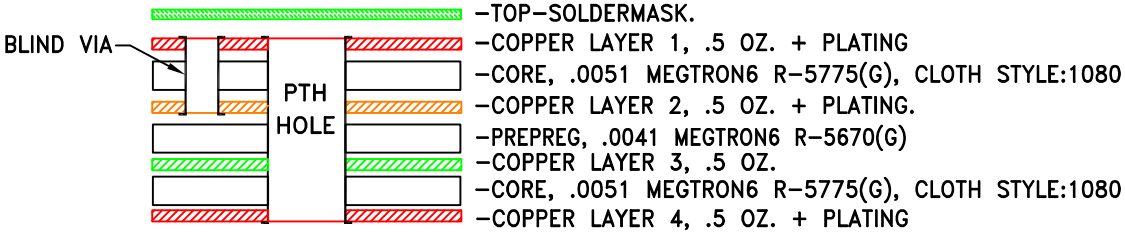
REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-013254	NEW RELEASE	05/16/22	ITG	IL
A	ECO-015587	UPDATED STACK-UP DIAGRAM	11/01/22	ITG	IL
B	ECO-020890	ADDED DIMENSIONS	02/16/24	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR NM1812C-3 CASE STYLE

TOP VIEW



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS 0.0228±.004.
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED PLUGGED PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. LAYER 4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	05/16/22
TOLERANCES ON:	CHECKED	GF	05/16/22
2 PL DECIMALS ±	APPROVED	IL	05/16/22
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

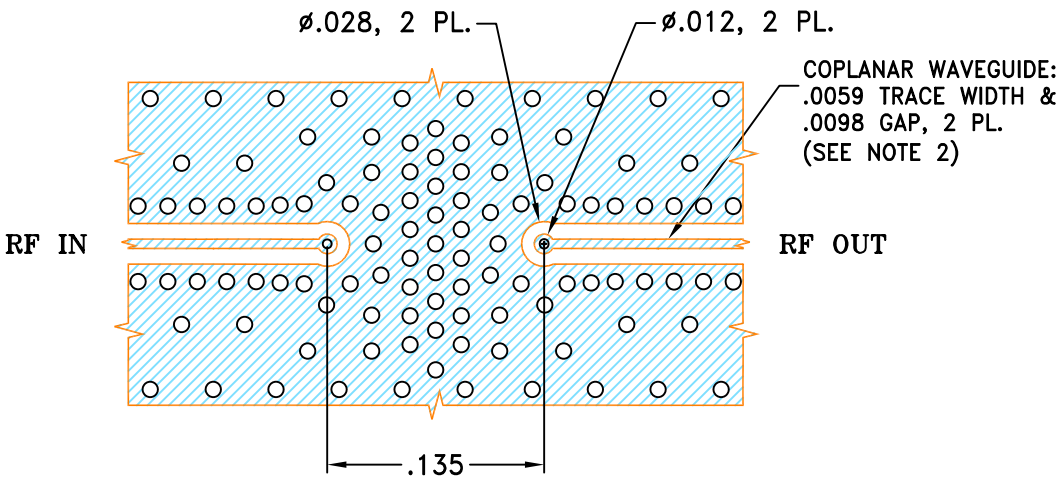
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PL, NM1812C-3, TB-1239

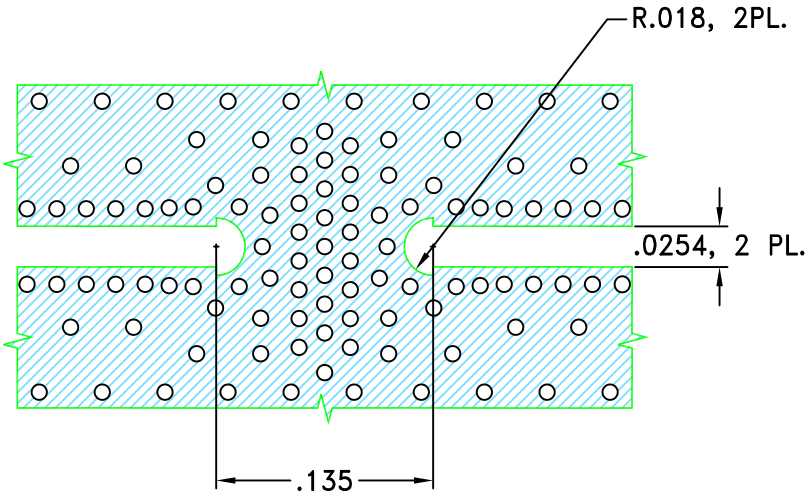
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B

FILE:	SCALE:	SHEET:
98PL730	8:1	1 OF 2

LAYER 2, B-VIA & PTH



LAYER 3 & PTH



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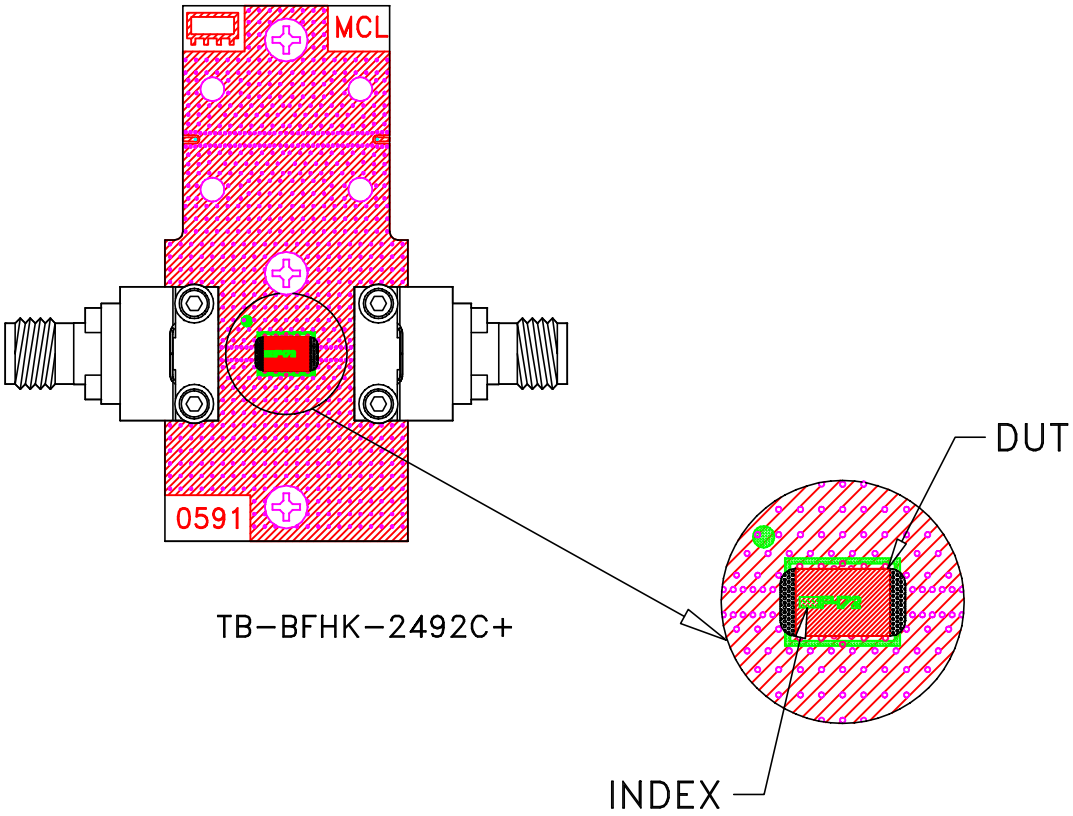
ASHEETA2.DWG REV:A DATE: 01/12/94

ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

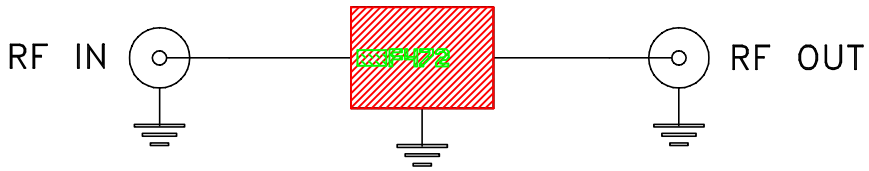
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B

FILE:	SCALE:	SHEET:
98PL730	8:1	2 OF 2

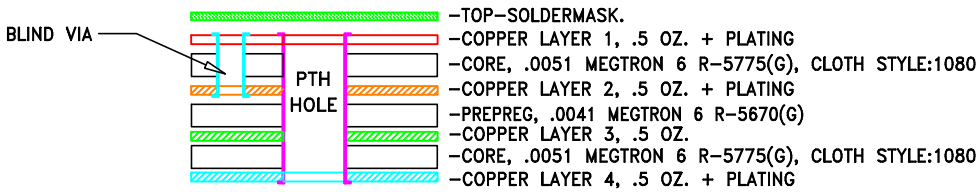
Evaluation Board and Circuit



TB-BFHK-2492C+



Schematic Diagram



STACK-UP DIAGRAM

Notes:

1. 1.85 mm Female End Launch Connector.
2. PCB Material: Megtron 6 R5775(N).
   Dielectric Constant=3.6.
3. Total finished thickness .023".

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Environmental Specifications ENV06T8

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	

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